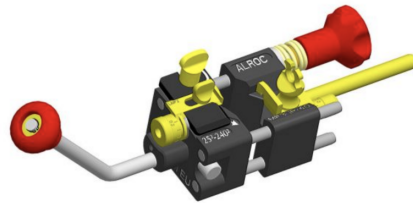




See online
technical sheet

/ MF3NP/40 SERIE

Multifunction tool for outer sheath, bonded semiconductor and insulation



/ Use

The MF3NP/40 tools enables the user to :

- > Remove the outer sheath (PE-PVC-PR) with a straight and neat cut.
 - > Remove the bonbed semiconductor with a chamfer and a minimum remaining length of semiconductor of 40 mm
 - > Remove the insulation with a neat and straight cut
- Silicon required for the removal of bonded semiconductor

/ Advantages

- Robust design
- 3 in 1 tools : sheath - peelable semicon - insulation

/ Technical specifications

- **Specific tools** : Cable tools
- **Cable tools** : Cable tools
- **For network cables** : medium voltage
- **Packaging** : Carton box
- **Max diameter (mm)** : 40
- **Tools king** : Specific tools

/ Spare parts

	Reference	Designation
	LMF2 SERIE	Insulation and sheath blades

Weight	Lenght	Width	Height	Max diameter
1,03 kg	165 mm	80 mm	100 mm	40 mm